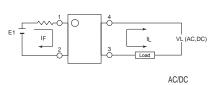
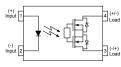
Load Voltage:400V Load Current:120mA SOP-4

APSEMI®

Parameter	Symbol	Rating	Units	
Load Voltage	VL	400	V	
Load Current	lL .	0.12	Α	
On-Resistance	Ron	20	Ω	
I/O Breakdown Voltage	V/io	2500	Vrms	







- 1. LED Anode
- 2. LED Cathode
- 3.4. Drain(MOS FET)



APSEMI PhotoRelays

- Long life (No limit on mechanical and electrical
- lifetime)Bounce-free switching
- Higher speed and high frequency switching
- Higher sensitivity (less power consumption)
- Immunity to EMI or RFI

- No have voltaic arc, bounce, and noise More
- resistant to vibration and impact AC or DC load
- switching
- Small package size

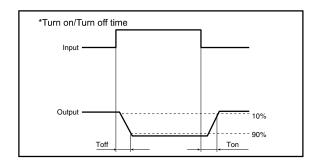
Applications

- Telecom/Datacom switching
- Multiplexers
- Meter reading systems
- Data acquisition
- Medical equipment
- Battery monitoring I/O Sub-Systems

- Robotics
- Aerospace
- Home/Safety security systems
- Process Control
- **Energy Management**
- Reed Relay EMR Replacement
- Programmable Controllers

TPYES

Output Rating		Doolsons	Part No.	Decking Overtity		
Category	Load Voltage	Load Current	Package	Part No.	Packing Quantity	
AC/DC	400V	0.12A	SOP-4	GAQY414S	2000pcs /reel	





Absolute Maximum Ratings (Ta = 25°C)

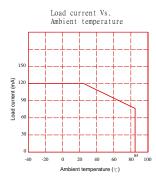
	Item	Symbol	Va l ue	Units	Note
Input	Continuous LED Current	I F	50	mA	
	Peak LED Current	Iгр	500	mA	f=100Hz, duty=1%
	LED Reverse Voltage	VR	5	V	
	Input Power Dissipation	P _{In}	75	mW	
	Load Voltage	VL	400	V(AC peak or DC)	
	Load Current	IL	0.12	A	
Output	Peak Load Current	Peak	0.3	Α	100ms(1 pulse)
	Output Power Dissipation	Pout	500	mW	
Total Power	Dissipation	Р⊤	550	mW	
I/O Breakdov	vn Vo l tage	V _{I/O}	2500	Vrms	RH=60%, 1min
Operating Te	emperature	Topr	-40 to 85	℃	
Storage Tem	perature	T _{stg}	-40 to 100	℃	
Pin Soldering	g Temperature	T _{sol}	260	℃	10 sec max.

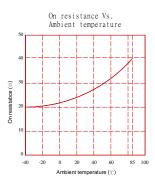
Electrical Characteristics (Ta = 25°C)

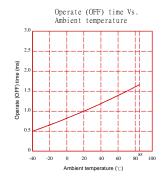
	Item	Symbol	MIN.	TYP.	MAX.	Units	Conditions
	LED Forward Voltage	VF		1.2	1.4	V	I⊧=10mA
	Operation LED Current	Fon		0.5	3.0	mA	
Input	Recovery LED Current	Foff		0.35	0.5	mA	
	Recovery LED Voltage	V _{Foff}	0.5			V	
							I⊧=0mA,I∟=Max
	On-Resistance	Ron		20	50	Ω	Time to flow is within 1 sec.
	Off-State Leakage	Leak			1	uA	V _∟ =Rating
	Current	Leak			•	G, t	vi raing
	Output Capacitance	Cout		165		pF	V∟=0, f=1MHz
Transmis	Turn-On Time	Ton		0.5	3.0	ms	I⊧=5mA, I∟=Max ,
sion	Turn-Off Time	Toff		0.02	1.0	ms	
Coupled	I/O Isolation Resistance	R _{I/O}	10 ¹⁰			Ω	DC500V
Coupled	I/O Capacitance	C _{I/O}		0.8	1.5	pF	f=1MHz

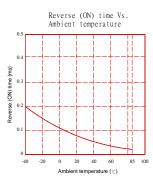
Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value): IF \geq 5mA and \leq 30mA

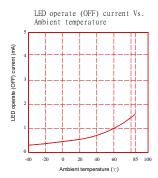
Engineering Data

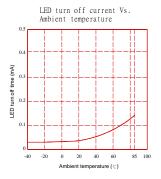


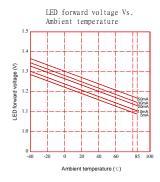


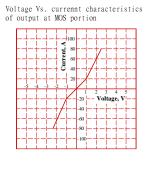


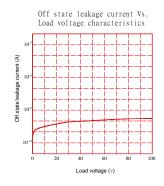


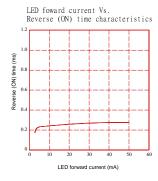


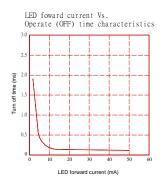


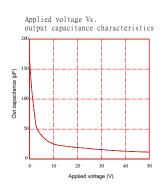




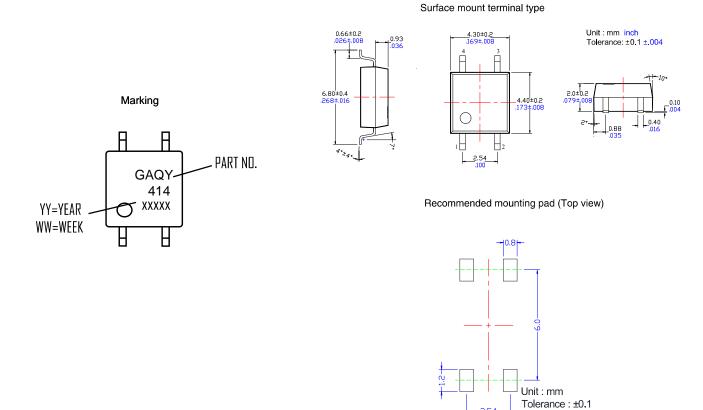




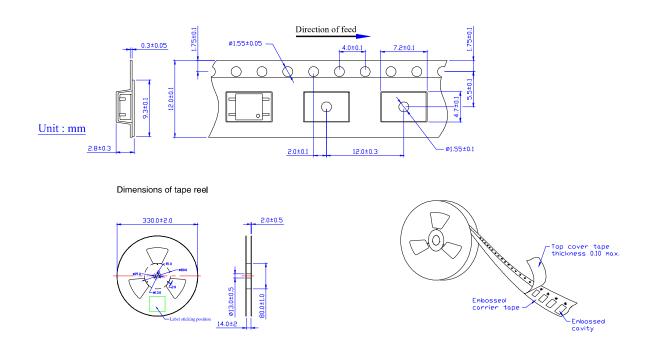




Dimensions and Package



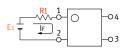
Tape dimensions

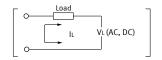




Using Methods

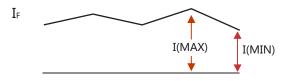
Examples of resistance value to control LED forward current (IF=5mA)





E1	R1 (Approx)
3.3V	300 Ω
5.0V	600 Ω
12V	1.9KΩ
24V	4.1K Ω

LED forward current must be more than 5mA , at I(MIN) ,and less than 30mA , at I(MAX).



Recommended Operating Conditions

Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value):

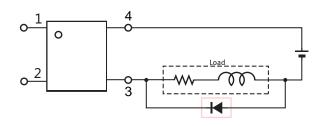
Characteristic	Symbol	Min	Тур.	Max	Unit
Forward current	lF	5.0	7.0	30	mA

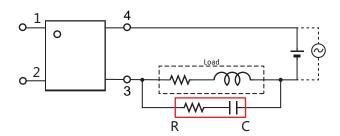
Protection Circuit

Output spike voltages:if an inductive load generates spike voltages which exceed heabsolute maximum rating, the spike voltage shall be limited.

Clamp diode is connected in parallel with the load. Absorb capacity with external diode.

CR Snubber is connected in parallel with the load. Absorb capacity with buffer capacity.





When adding diodes, buffer circuits (C-R), and other protections, they need to be installed near the MOS RELAY to be effective. Adding protection elements may result in a slow reset time, so adjust them according to the actual situation before use.

Note: When developing designs using this product, perform the expected performance of the equipment under the operating conditions recommended by the guidelines in this document. Continuous use under heavy loads (including, but not limited to, the application of high temperatures/current/voltage and significant changes in temperature, etc.) may result in deterioration of the reliability of this product.